

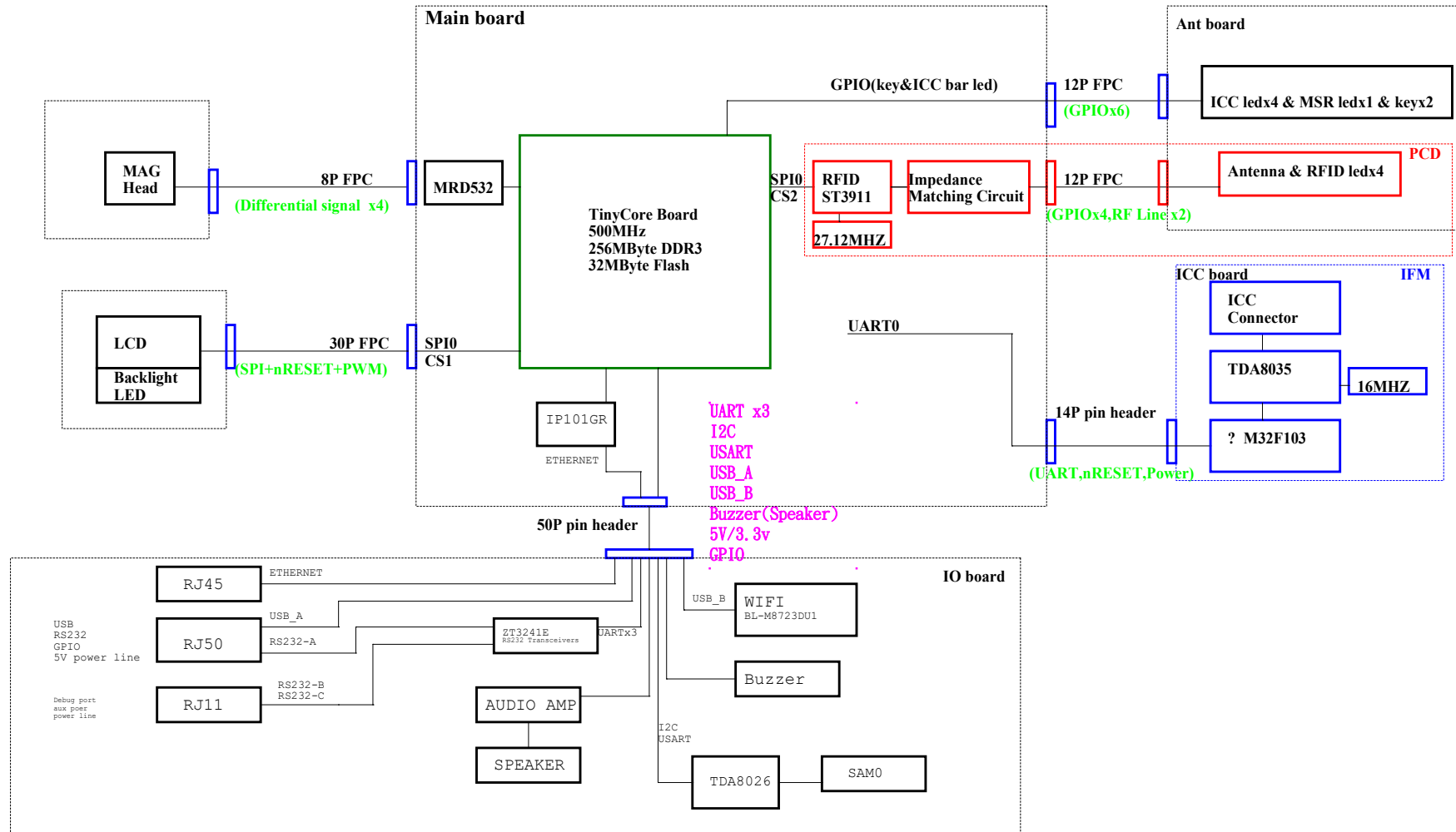
Revision History

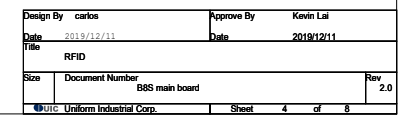
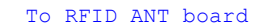
Rev. Code	Date	By	Description
1.0	2019-07-23	carlos	1 release Rev 1.0 to layout
2.0	2019-11-20	carlos	1 release Rev 2.0 to layout
A	2021-01-09	Gary	For EMV3.0: C17,C24 from 220pF change to 180pF(CCA181J610-R) Del C20,C26 C22 from 220pF change to 15pF(CCA150F610-R) C32,C35 from 39pF change to 68pF(CCA680J610-R)
A.1	2022-10-05	Gary	Update Schematic for TQM. Main Board Y1,C29,C31,R35 from PART B1 change to PART A ECR change TQM BOM description.

Green:Com(B1)=PCD(B1),IFM(B1)

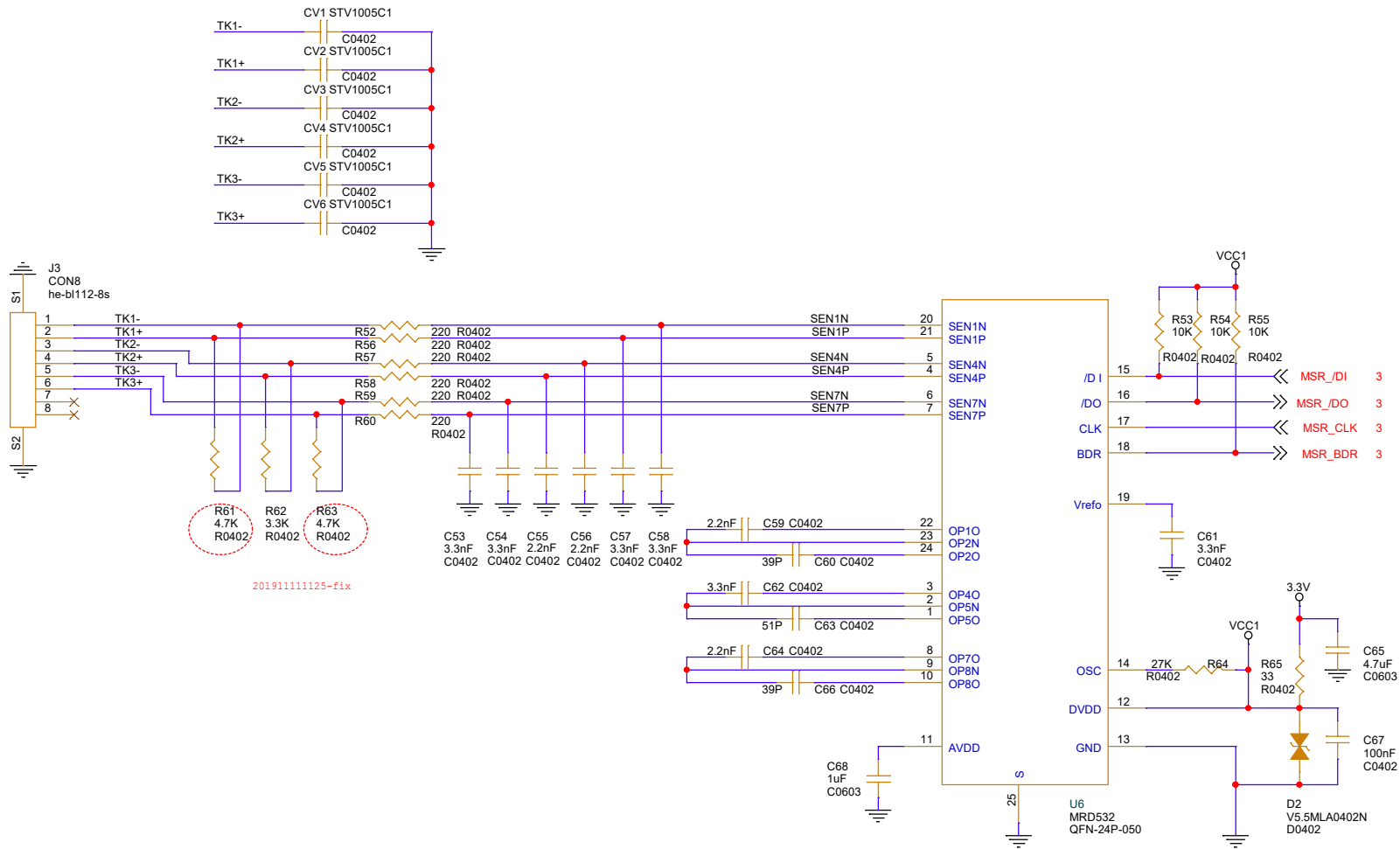
Red:PCD(A),PCD(B1)

Blue:IFM(A),IFM(B1)





Mag. Head



Design By	carlos	Approve By	Kevin Lai
Date	2019/11/20	Date	2019/11/20
Title			
MSR			
Size	Document Number		Rev
	B8S main board		2.0
UIC Uniform Industrial Corp.		Sheet	5 of 8

Design By carlos		Approve By Kevin Lai	
Date 2019/11/20		Date 2019/11/20	
Title connector			
Size	Document Number B8S main board		Rev 2.0
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